

RS432

Adjustable Precision Shunt Regulator

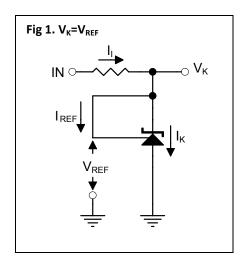
General Description

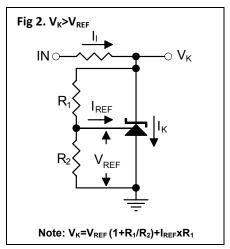
The RS432 series are three-terminal adjustable regulators with guaranteed thermal stability over applicable temperature ranges. The output voltage may be set to any value between V_{REF} (approximately 1.24 or 1.25 volts) and 18 volts with two external resistors. These devices have a typical dynamic output impedance of 0.2 Ω . Active output circuitry provides a very sharp turn-on characteristic, making these devices excellent replacement for zener diodes in many applications.

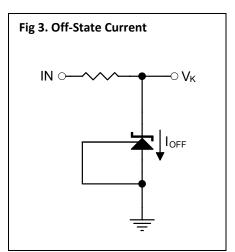
Features

- Programmable Precise Output Voltage from 1.24V or 1.25V to 16V
- High Stability under Capacitive Load
- Low Dynamic Output Resistance: 0.2Ω Typical
- Fast turn on response
- Low Output Noise
- Wide Operating Range of -40 to 125°C
- Low Equivalent Full-range Temperature Coefficient with 50ppm/°C Typical
- SOT-23, SOT-89 and TO-92 Packages
- RoHS Compliant and 100% Lead (Pb)-Freeand Green (Halogen Free with CommercialStandard)

Application Circuits









This integrated circuit can be damaged by ESD. Orister Corporation recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.



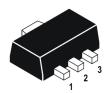
Pin Assignments

SOT-23 SOT-89

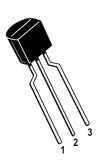
TO-92 (STRAIGHT LEAD OPTION)

TO-92 (FORMED LEAD OPTION)









PACKAGE	PIN	DESCRIPTION
	1	REFERENCE
SOT-23	2	CATHODE
	3	ANODE

PACKAGE	PIN	DESCRIPTION	
1		REFERENCE	
SOT-89	2	ANODE	
	3	CATHODE	

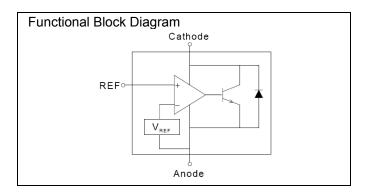
PACKAGE	PIN	DESCRIPTION	
TO-92 2		REFERENCE	
		ANODE	
	3	CATHODE	

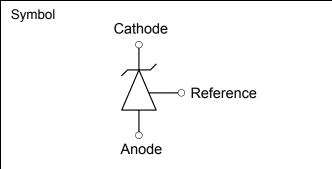
Ordering Information

DEVICE	DEVICE CODE	
	X is Reference voltage precision designator:	
	A: 1.24V ±2.0%	
	B: 1.24V ±1.0%	
	C: 1.24V ±0.5%	
	D: 1.25V ±2.0%	
	E: 1.25V ±1.0%	
	F: 1.25V ±05%	
RS432 X YY Z	YY is package designator :	
	N: SOT-23	
	M: SOT-89	
	A: TO-92 (Straight lead option)	
	AT: TO-92 (Formed lead option)	
	Z is Lead Free designator :	
	P: Commercial Standard, Lead (Pb) Free and Phosphorous (P) Free Package	
	G: Green (Halogen Free with Commercial Standard)	



Block Diagram





Absolute Maximum Ratings (Operating temperature range applies unless otherwise specified)

Characteristics	Symbol	ol Value		Unit
Cathode Voltage	Cathode Voltage V _{KA} 18		8	V
Cathode Current Range (Continuous)	I _K	20	0	mA
Reference Input Current Range	I _{REF}	10		mA
		SOT-23	370	
Dawer Dissination	ь	SOT-89	770	
Power Dissipation	P_{D}	TO-92	770	mW
Operating Temperature Range (Max.)	T_{OPR}	-40 - +125		°C
Storage Temperature Range	T _{STG}			°C

Operating Conditions

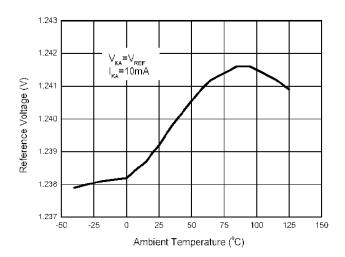
Characteristics	Symbol	Min.	Max.	Unit
Cathode Voltage	V_{KA}	V_{REF}	16	V
Cathode Current Range (Continuous)	I _K	0.1	20	mA
Operating Ambient Temperature Range	T _{OPR}	-40	125	°C

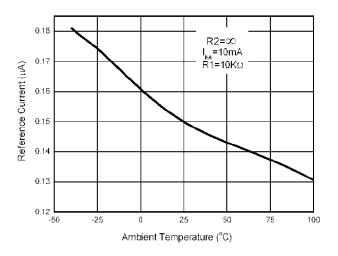
Electrical Characteristics (T_A=25°C, unless otherwise specified)

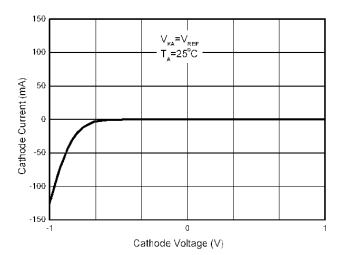
Characteristics		Symbol	Test Conditions	Min	Тур	Max	Unit
	1.24V ±2.0%	- V _{REF}	V _K =V _{REF} , I _K =10mA	1.215	1.24	1.265	. V
	1.24V ±1.0%			1.228	1.24	1.252	
Defense as Innert Valtage (Fig.1)	1.24V ±0.5%			1.234	1.24	1.246	
Reference Input Voltage (Fig1)	1.25V ±2.0%			1.225	1.25	1.275	
	1.25V ±1.0%			1.238	1.25	1.262	
	1.25V ±0.5%			1.244	1.25	1.256	
Ratio of Change in Reference Input Voltage to the Change in Cathode Voltage (Fig2)		$\Delta V_{REF}/\Delta V_{K}$	I_K =10mA,, ΔV_K =18V to V_{REF}	-	1.0	2.7	mV/V
Reference Input Current (Fig2)		I _{REF}	I _K =10mA, R1=10KΩ, R2=∞	-	0.15	0.5	uA
Minimum Cathode Current for Regulation (Fig1)		I _{K(min)}	V _K =V _{REF}	-	20	80	uA
Off State Cathode Current (Fig.2)		I _{K(off)}	V _K =6V, V _{REF} =0	-	0.01	0.05	uA
Off-State Cathode Current (Fig3)			V _K =16V, V _{REF} =0		0.04	0.15	
Dynamic Output Impedance (Fig1)		Z _K	$V_K=V_{REF}$, f≤1kHz, $I_K=100$ uA to 20mA	-	0.2	0.4	Ω

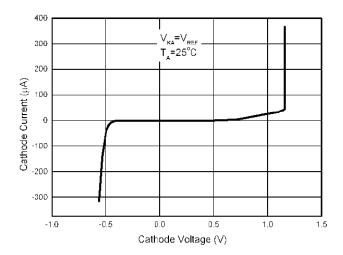


Typical Performance Characteristics

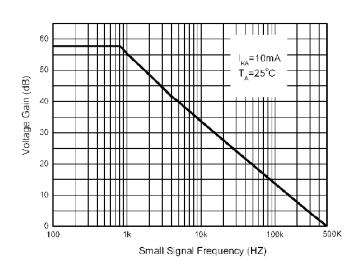


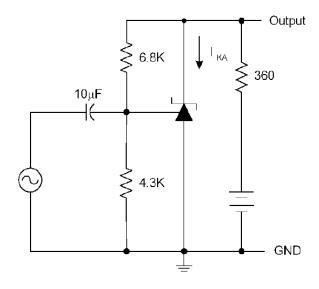


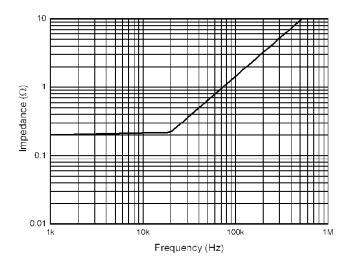


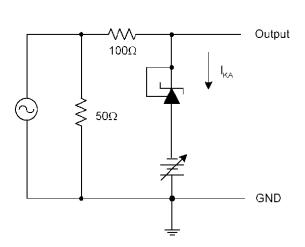


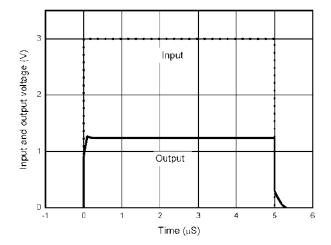


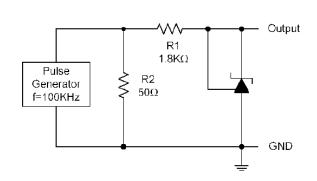






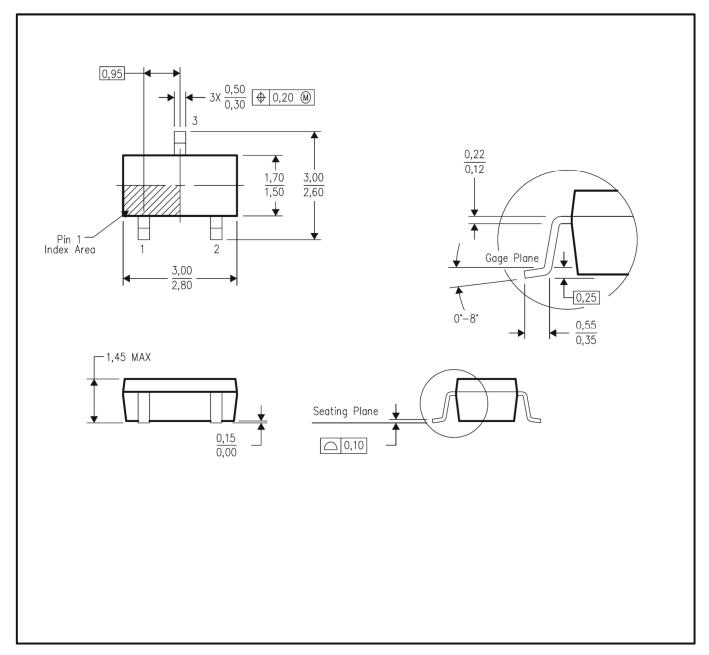








SOT-23 Dimension

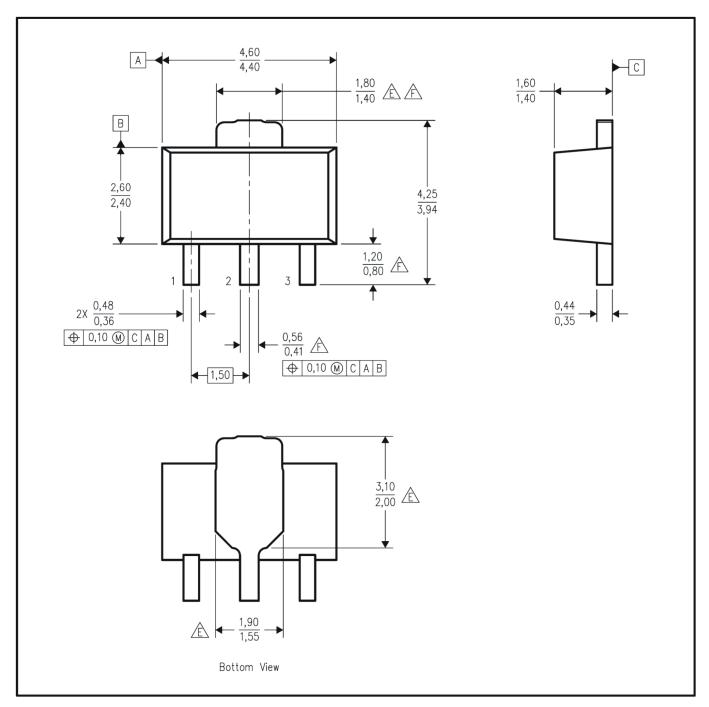


NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.



SOT-89 Dimension

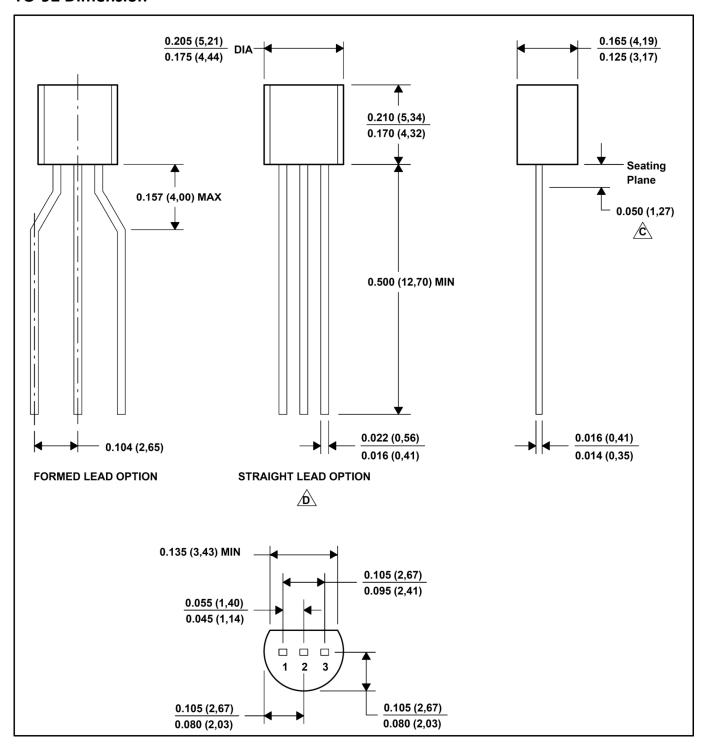


NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. The center lead is in electrical contact with the tab.
- D. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- E. Thermal pad contour optional within these dimensions.
- F. Falls within JEDEC TO-243 variation AA, except minimum lead length, pin 2 minimum lead width, minimum tab width.



TO-92 Dimension



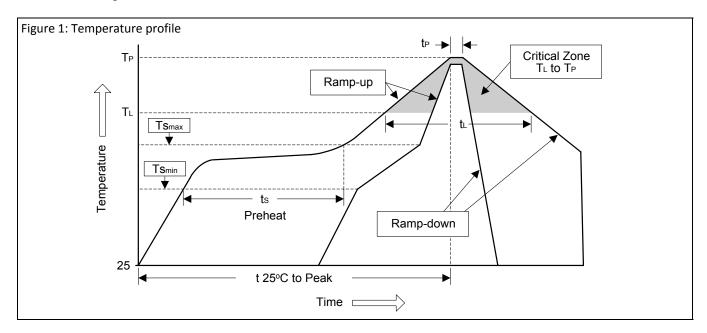
NOTES:

- G. All linear dimensions are in inches (millimeters).
- H. This drawing is subject to change without notice.
- I. Lead dimensions are not controlled within this area.
- J. Falls within JEDEC TO-226 variation AA (TO-226 replaces TO-92)
- K. Shipping Method:
 - Straight lead option available in bulk pack only.
 - Formed lead option available in tape & reel or ammo pack.



Soldering Methods for Orister's Products

- 1. Storage environment: Temperature= 10° C $^{\sim}35^{\circ}$ C Humidity= $65\%\pm15\%$
- 2. Reflow soldering of surface-mount devices



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Average ramp-up rate (T _L to T _P)	<3°C/sec	<3°C/sec	
Preheat			
- Temperature Min (Ts _{min})	100°C	150°C	
- Temperature Max (Ts _{max})	150°C	200°C	
- Time (min to max) (ts)	60~120 sec	60~180 sec	
Tsmax to T _L			
- Ramp-up Rate	<3°C/sec	<3°C/sec	
Time maintained above:			
- Temperature (T _L)	183°C	217°C	
- Time (t _L)	60~150 sec	60~150 sec	
Peak Temperature (T _P)	240°C +0/-5°C	260°C +0/-5°C	
Time within 5°C of actual Peak	10×20 coo	20240.505	
Temperature (t _P)	10~30 sec	20~40 sec	
Ramp-down Rate	<6°C/sec	<6°C/sec	
Time 25°C to Peak Temperature	<6 minutes	<8 minutes	

3. Flow (wave) soldering (solder dipping)

Products	Peak temperature	Dipping time
Pb devices.	245°C ±5°C	5sec ±1sec
Pb-Free devices.	260°C +0/-5°C	5sec ±1sec



Important Notice:

© Orister Corporation

Orister cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in an Orister product. No circuit patent licenses, copyrights, mask work rights, or other intellectual property rights are implied.

Orister reserves the right to make changes to their products or specifications or to discontinue any product or service without notice. Except as provided in Orister's terms and conditions of sale, Orister assumes no liability whatsoever, and Orister disclaims any express or implied warranty relating to the sale and/or use of Orister products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards. Testing and other quality control techniques are utilized to the extent Orister deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed.

Orister and the Orister logo are trademarks of Orister Corporation. All other brand and product names appearing in this document are registered trademarks or trademarks of their respective holders.